



SamHop Microelectronics Corp.

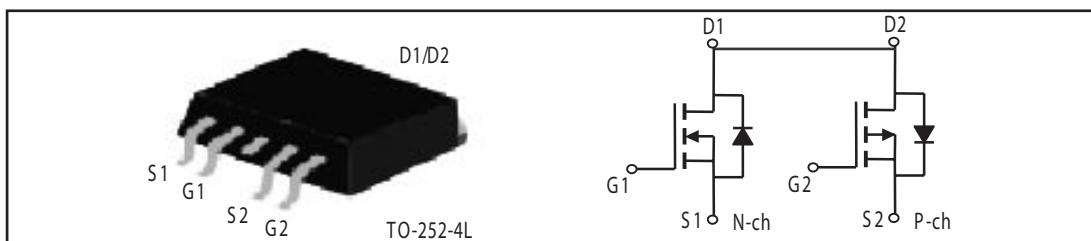
## STU405DH

Nov,20 2007 ver1.0

## Dual Enhancement Mode Field Effect Transistor ( N and P Channel)

PRODUCT SUMMARY (N-Channel)		
V <sub>DSS</sub>	I <sub>D</sub>	R <sub>D(S)ON</sub> ( m Ω ) Max
40V	11A	33 @ V <sub>GS</sub> = 10V
		45 @ V <sub>GS</sub> = 4.5V

PRODUCT SUMMARY (P-Channel)		
V <sub>DSS</sub>	I <sub>D</sub>	R <sub>D(S)ON</sub> ( m Ω ) Max
-40V	- 9A	45 @ V <sub>GS</sub> = -10V
		65 @ V <sub>GS</sub> = -4.5V

ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	V <sub>D</sub> S	40	-40	V
Gate-Source Voltage	V <sub>G</sub> S	±20	±20	V
Drain Current-Continuous @ T <sub>c</sub>	I <sub>D</sub>	11	- 9	A
		9	- 7	A
-Pulsed <sup>a</sup>	I <sub>D</sub> M	45	-36	A
Drain-Source Diode Forward Current	I <sub>S</sub>	7	-6	A
Maximum Power Dissipation	P <sub>D</sub>	11		W
		7.7		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 175		°C

## THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	R <sub>θJC</sub>	13.6	°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	120	°C/W

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N-Channel ELECTRICAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ <sup>c</sup>	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	40			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =32V, V <sub>GS</sub> =0V		1		μA
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V		±100		nA
<b>ON CHARACTERISTICS <sup>a</sup></b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1	1.5	3	V
Drain-Source On-State Resistance	R <sub>D(S)ON</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =8A		24	33	m ohm
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =6A		30	45	m ohm
On-State Drain Current	I <sub>D(ON)</sub>	V <sub>DS</sub> =5V, V <sub>GS</sub> =4.5V	20			A
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =8A		13.8		S
<b>DYNAMIC CHARACTERISTICS <sup>b</sup></b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V f=1.0MHz		580		pF
Output Capacitance	C <sub>OSS</sub>			82		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			50		pF
<b>SWITCHING CHARACTERISTICS <sup>b</sup></b>						
Turn-On Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> =20V I <sub>D</sub> =1 A V <sub>GS</sub> =10V R <sub>GEN</sub> =3.3 ohm		11		ns
Rise Time	t <sub>r</sub>			10.2		ns
Turn-Off Delay Time	t <sub>D(OFF)</sub>			17.3		ns
Fall Time	t <sub>f</sub>			20		ns
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =28V, I <sub>D</sub> =8A, V <sub>GS</sub> =10V		11.3		nC
		V <sub>DS</sub> =28V, I <sub>D</sub> =8A, V <sub>GS</sub> =4.5V		5.8		nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =28V, I <sub>D</sub> =8 A V <sub>GS</sub> =10V		1.2		nC
Gate-Drain Charge	Q <sub>gd</sub>			2.9		nC

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P-Channel ELECTRICAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ <sup>c</sup>	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-40			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -32V, V <sub>GS</sub> = 0V			-1	μA
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100	nA
<b>ON CHARACTERISTICS <sup>a</sup></b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-1	-1.7	-3	V
Drain-Source On-State Resistance	R <sub>D(S(ON))</sub>	V <sub>GS</sub> = -10V, I <sub>D</sub> = -6A		35	45	m ohm
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -4A		52	65	m ohm
On-State Drain Current	I <sub>D(ON)</sub>	V <sub>DS</sub> = -5V, V <sub>GS</sub> = -10V	-20			A
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> = -10V, I <sub>D</sub> = -6A		12		S
<b>DYNAMIC CHARACTERISTICS <sup>b</sup></b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> = -25V, V <sub>GS</sub> = 0V f = 1.0MHz		980		pF
Output Capacitance	C <sub>OSS</sub>			135		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			90		pF
<b>SWITCHING CHARACTERISTICS <sup>b</sup></b>						
Turn-On Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> = -20V I <sub>D</sub> = -1A V <sub>GS</sub> = -10V R <sub>GEN</sub> = 3.3 ohm		12		ns
Rise Time	t <sub>r</sub>			17		ns
Turn-Off Delay Time	t <sub>D(OFF)</sub>			82		ns
Fall Time	t <sub>f</sub>			35		ns
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = -28V, I <sub>D</sub> = -6A, V <sub>GS</sub> = 10V		20.7		nC
		V <sub>DS</sub> = -28V, I <sub>D</sub> = -6A, V <sub>GS</sub> = -4.5V		11		nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = -28V, I <sub>D</sub> = -6 A V <sub>GS</sub> = -10V		1.5		nC
Gate-Drain Charge	Q <sub>gd</sub>			6.2		nC

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ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ <sup>c</sup>	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS <sup>b</sup>						
Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0\text{V}, I_S = 7\text{A}$ $V_{GS} = 0\text{V}, I_S = -6\text{A}$	N-Ch P-Ch	0.98 -0.9	1.2 -1.2	V

Notes

a. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

b. Guaranteed by design, not subject to production testing.

N-Channel

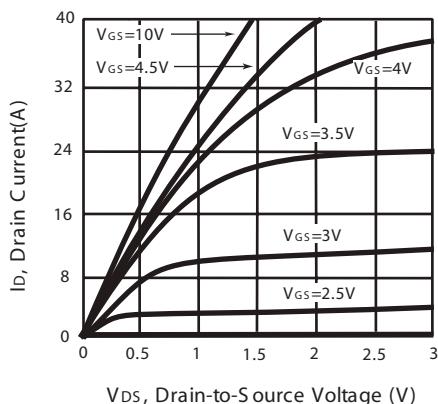


Figure 1. Output Characteristics

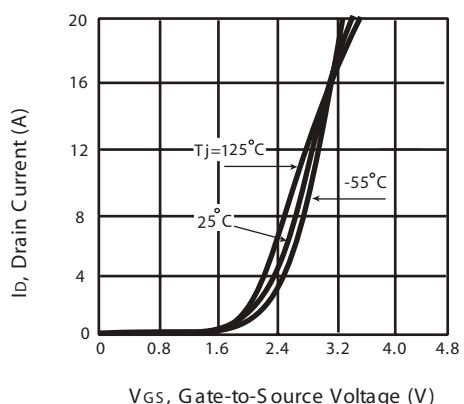


Figure 2. Transfer Characteristics

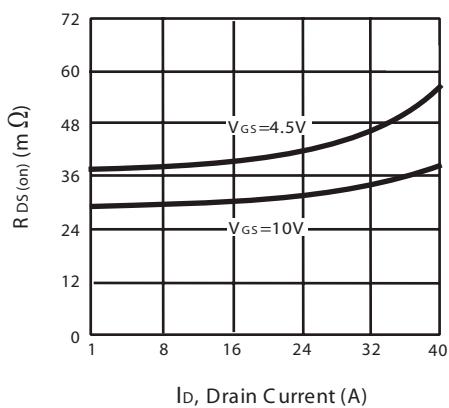


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

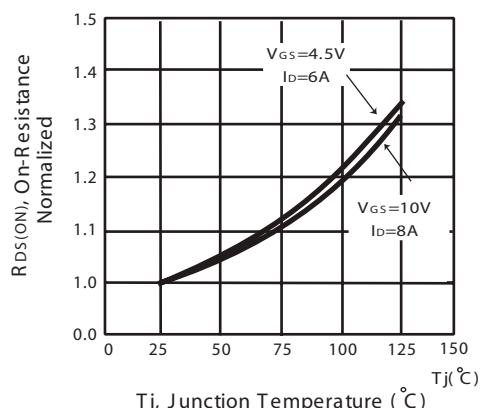


Figure 4. On-Resistance Variation with Drain Current and Temperature

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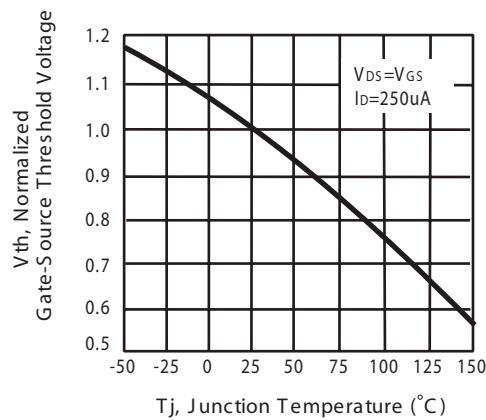


Figure 5. Gate Threshold Variation with Temperature

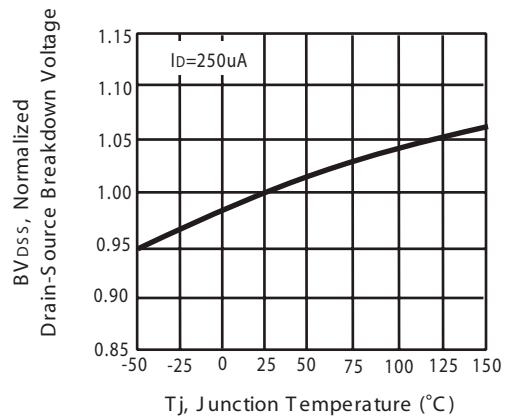


Figure 6. Breakdown Voltage Variation with Temperature

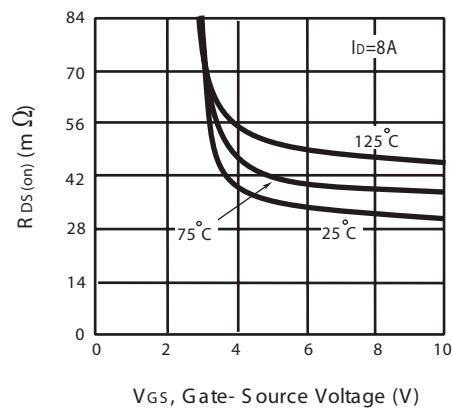


Figure 7. On-Resistance vs. Gate-Source Voltage

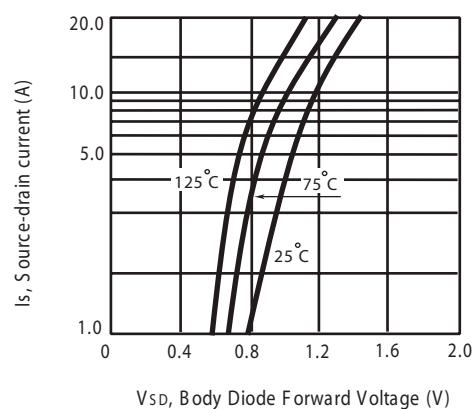


Figure 8. Body Diode Forward Voltage Variation with Source Current

# STU405DH

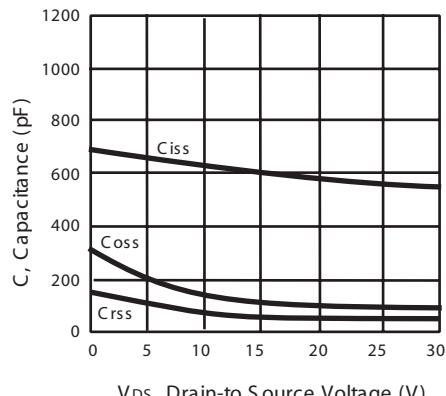


Figure 10. Capacitance

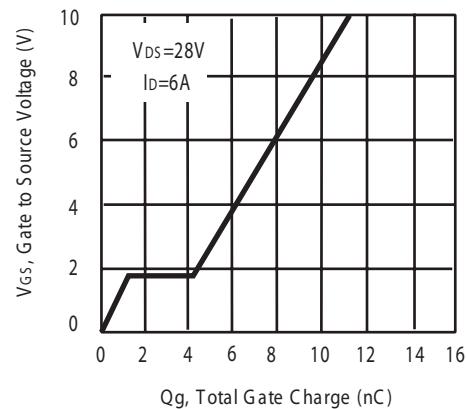


Figure 11. Gate Charge

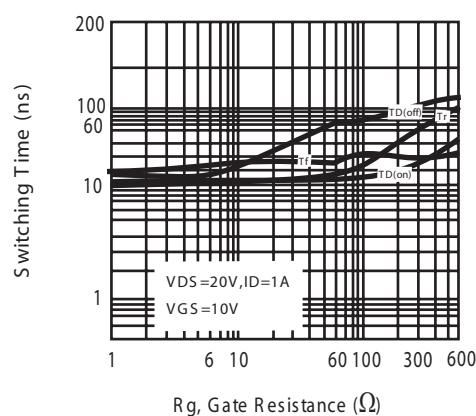


Figure 12. switching characteristics

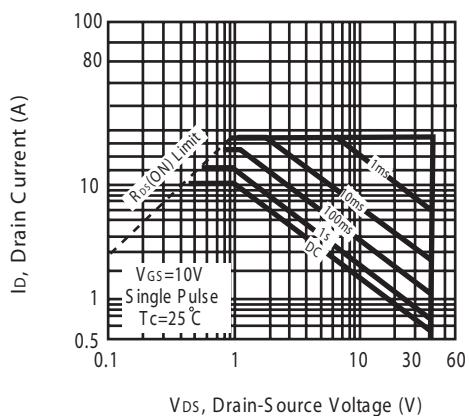


Figure 13. Maximum Safe Operating Area

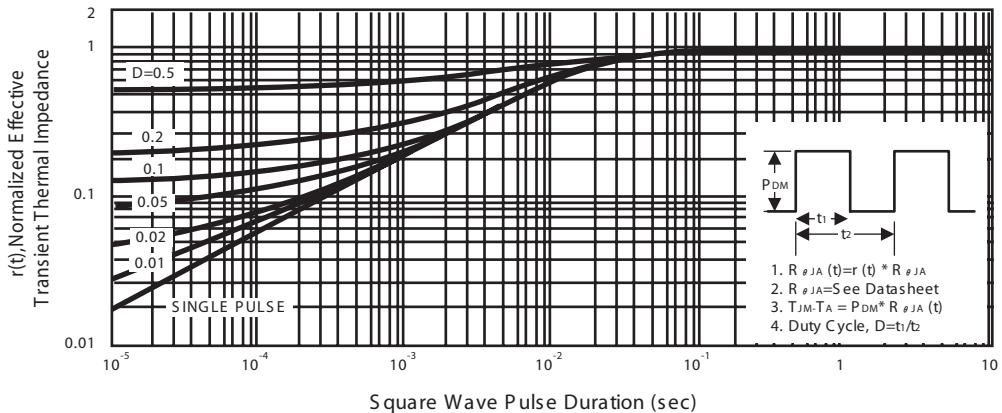


Figure 14. Normalized Thermal Transient Impedance Curve

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## P-Channel

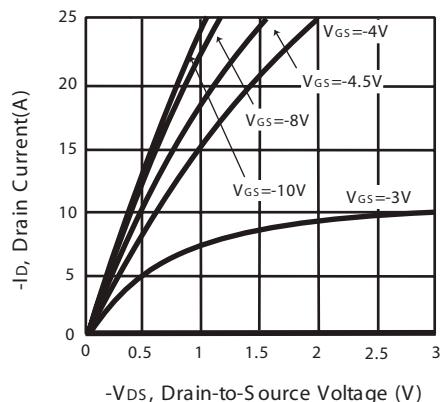


Figure 1. Output Characteristics

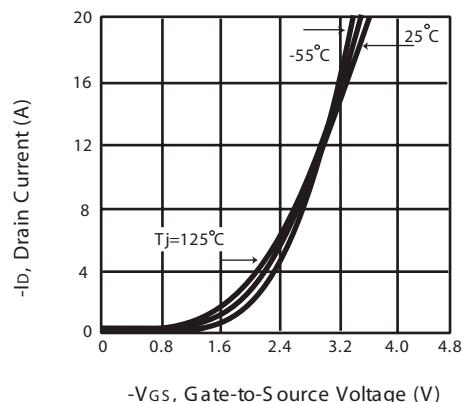


Figure 2. Transfer Characteristics

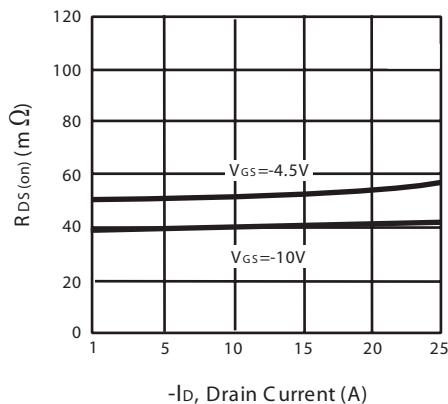


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

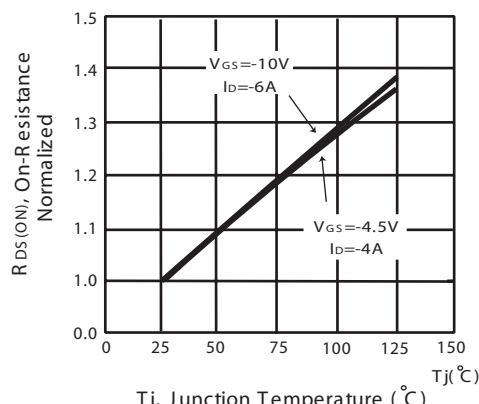


Figure 4. On-Resistance Variation with Drain Current and Temperature

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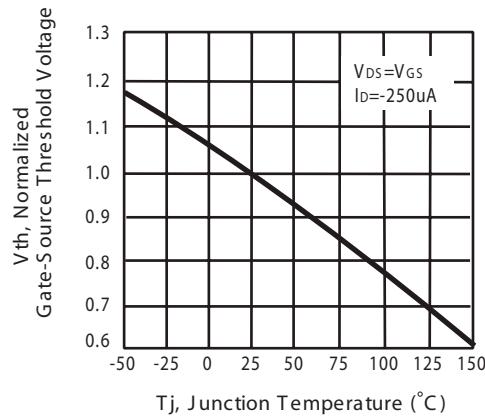


Figure 5. Gate Threshold Variation with Temperature

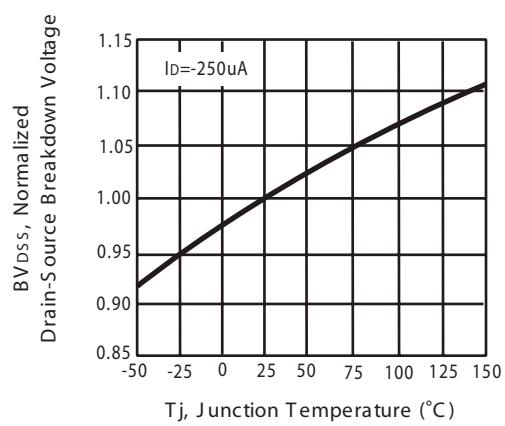


Figure 6. Breakdown Voltage Variation with Temperature

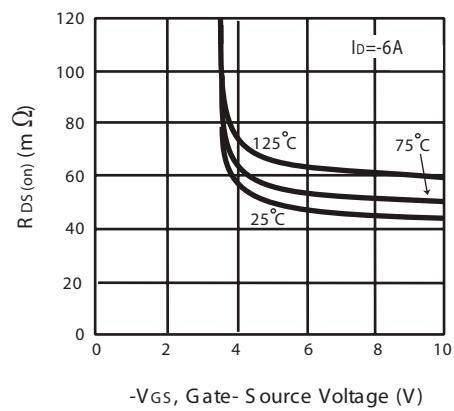


Figure 7. On-Resistance vs. Gate-Source Voltage

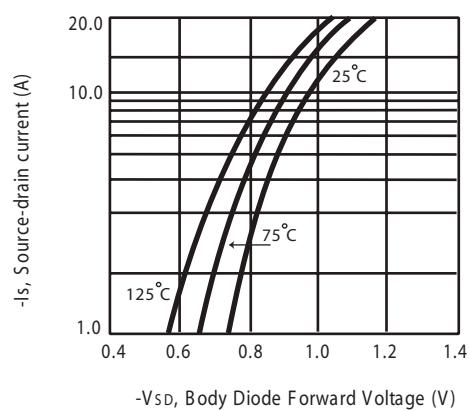


Figure 8. Body Diode Forward Voltage Variation with Source Current

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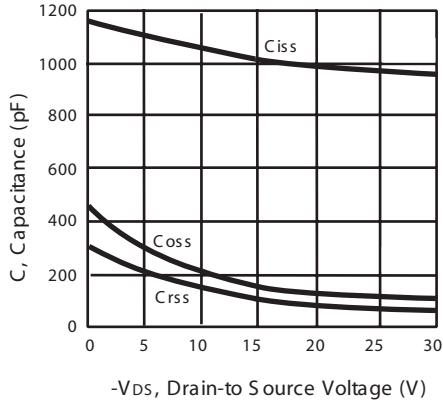


Figure 9. Capacitance

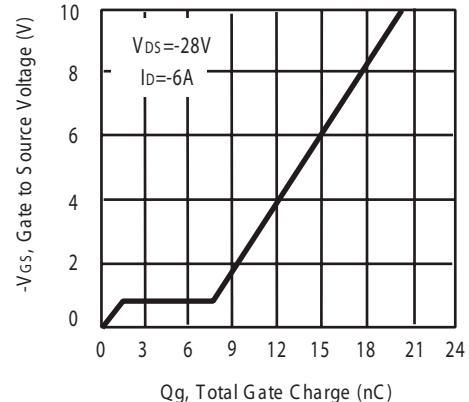


Figure 10. Gate Charge

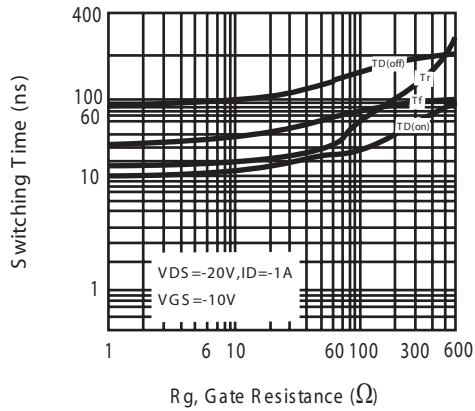


Figure 11. switching characteristics

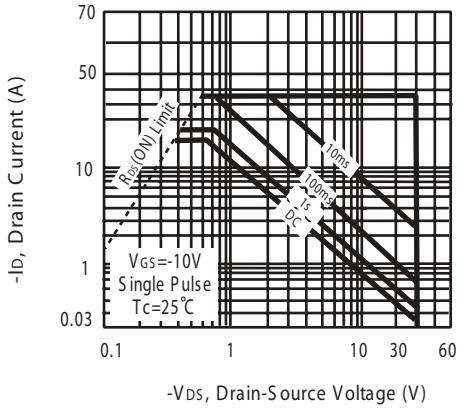


Figure 12. Maximum Safe Operating Area

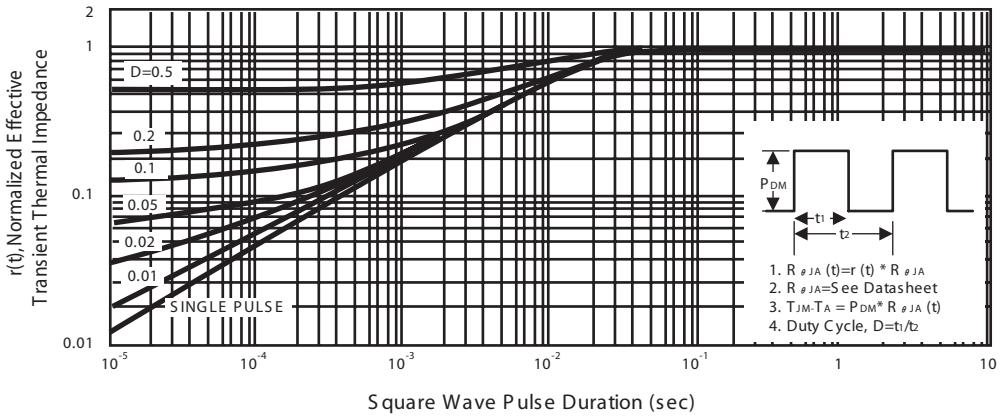
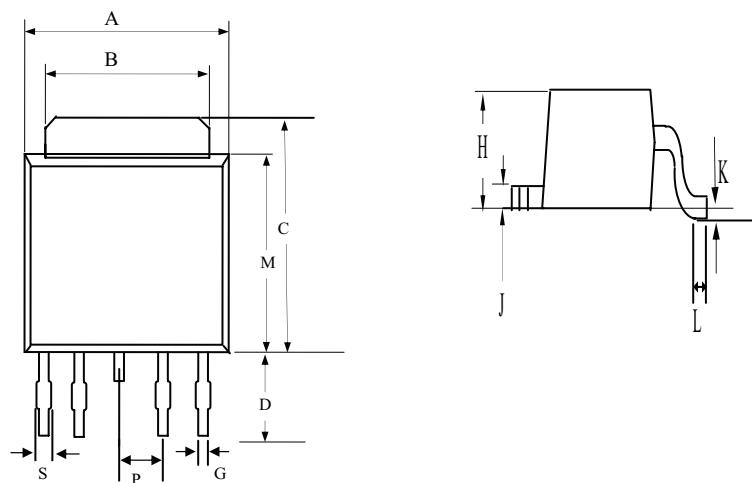


Figure 13. Normalized Thermal Transient Impedance Curve

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## PACKAGE OUTLINE DIMENSIONS

TO-252-4L

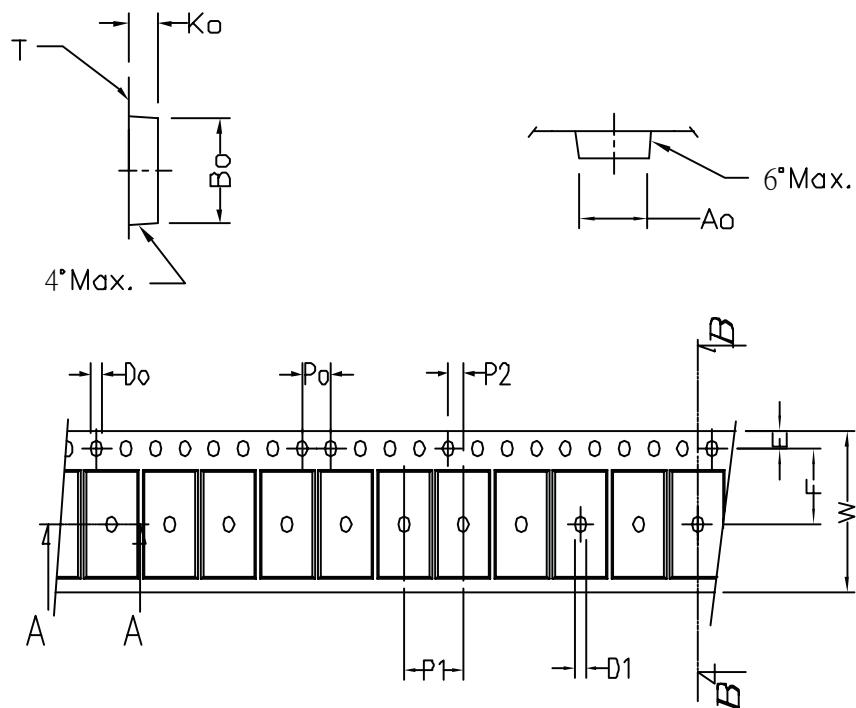


REF.	Millimeters	
	MIN	MAX
A	6.40	6.80
B	5.2	5.50
C	6.80	10.20
D	2.20	3.00
P	1.27 REF.	
S	0.50	0.80
G	0.40	0.60
H	2.20	2.40
J	0.45	0.60
K	0	0.15
L	0.90	1.50
M	5.40	5.80

# STU405DH

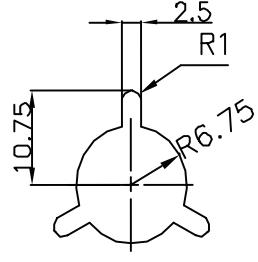
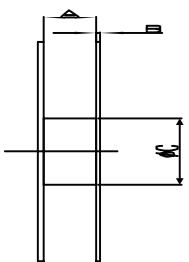
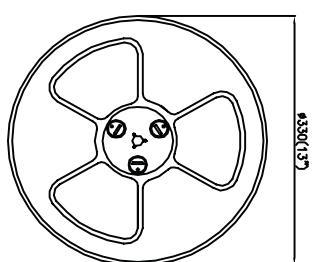
## TO-252-5L Tape and Reel Data

TO-252-5L Carrier Tape



symbol	Ao	Bo	Ko	P0	P1	P2	T
Spec	$6.96 \pm 0.1$	$10.49 \pm 0.1$	$2.79 \pm 0.1$	$4.0 \pm 0.1$	$8.0 \pm 0.10$	$2.0 \pm 0.05$	$0.33 \pm 0.013$
symbol	E	F	D0	D1	W	10P0	
Spec	$1.75 \pm 0.1$	$7.5 \pm 0.05$	$1.55 \pm 0.05$	$1.5 \pm 0.25$	$16.0^{+0.3}_{-0.1}$	$40.0 \pm 0.2$	

TO-252-5L Reel



UNIT:mm

Width of carrier tape	8	12	16	24	32	44	56
$A \pm 0.1$	9.4	13.4	17.4	25.4	33.4	45.4	57.4
B	2.3	2.3	2.3	2.3	2.3	2.3	2.3
$\phi C$	100	100	100	100	100	100	100